#### 503118996 12/30/2014

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
HIDEKAZU MIYAIRI	12/10/2014
SHINYA SASAGAWA	12/10/2014

### **RECEIVING PARTY DATA**

Name:	SEMICONDUCTOR ENERGY LABORATORY CO., LTD.	
Street Address:	398, HASE	
City:	ATSUGI-SHI, KANAGAWA-KEN	
State/Country:	JAPAN	
Postal Code:	243-0036	

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14578683

#### CORRESPONDENCE DATA

Fax Number: (877)769-7945

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: (202) 783-5070 Email: apsi@fr.com

Correspondent Name: JOHN F. HAYDEN

Address Line 1: FISH & RICHARDSON P.C.

Address Line 2: P.O.BOX 1022

Address Line 4: MINNEAPOLIS, MINNESOTA 55440-1022

**ATTORNEY DOCKET NUMBER:** 12732-1397001 NAME OF SUBMITTER: APRIL K. SAUNDERS-FULLER SIGNATURE: /April K. Saunders-Fuller/ **DATE SIGNED:** 12/30/2014

**Total Attachments: 1** 

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**PATENT** REEL: 034601 FRAME: 0146 503118996

# **ASSIGNMENT**

For valuable consideration, We, <u>Hidekazu MIYAIRI of Hadano, Kanagawa, Japan and Shinya SASAGAWA of Chigasaki, Kanagawa, Japan</u> hereby assign to <u>Semiconductor Energy Laboratory Co., Ltd.</u>, a <u>Japanese</u> corporation having a place of business at:

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and				
interest throughout the world in the inventions and improvements which are subject of an application for				
United States Patent signed by us this day, entitled SEMICONDUCTOR DEVICE,				
filed December 22, 2014, and assigned U.S. Serial Number 14/578,683, and we				
authorize and request the attorneys appointed in said application to hereafter complete this assignment by				
inserting above the filing date and serial number of said application when known; this assignment including				
said application, any and all United States and foreign patents, utility models, and design registrations				
granted for any of said inventions or improvements, and the right to claim priority based on the filing date of				
said application under the International Convention for the Protection of Industrial Property, the Patent				
Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and we				
authorize the Assignee to apply in all countries in our name or in its own name for patents, utility models,				
design registrations and like rights of exclusion and for inventors' certificates for said inventions and				
improvements; and we agree for ourselves and our respective heirs, legal representatives and assigns,				
without further compensation to perform such lawful acts and to sign such further applications, assignments,				
Preliminary Statements and other lawful documents as the Assignee may reasonably request to effectuate				
fully this assignment.				

Signature

Name: Hidekazu MIYAIRI

Date: /2/10/2014

Signature Shinya SASAGAWA

Name: Shinya SASAGAWA

Date: /2/10/2014

PATENT REEL: 034601 FRAME: 0147

**RECORDED: 12/30/2014**